Quartz Crystal Primer-Part 1

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Introduction
For crystal oscillator design and engineering success, the design engineer must first understand the crystal resonator.
The crystal, as the highest Q component in the oscillator circuit, will have the most impact on the circuit. Therefore, correctly specifying the crystal is critical to a well-designed oscillator. This mini primer will cover some of the most misunderstood parameters of a quartz crystal.

Figure 1 shows the electrical equivalent circuit of the crystal resonator.

![Crystal Symbol and its Single Mode, 1-Port, Crystal Resonator Equivalent Circuit](image)

**Figure 1:** Crystal Symbol and its Single Mode, 1-Port, Crystal Resonator Equivalent Circuit

In Figure 1, C1, L1 and R1 form the motional arm of the crystal resonator. C0 is the Shunt capacitance, which is primarily formed from the electrodes of the crystal plus the strays of the holder. The shunt capacitance C0 is the only physical value in the equivalent circuit. This parameter can actually be measured with a simple capacitance meter. The motional arm components (C1, L1 and R1), on the other hand, are equivalents and, therefore, are not real. Note that this equivalent is for the fundamental response only, and additional motional arms can be added for each of the overtones and spurious.

The Impedance equation for the crystal equivalent circuit of Figure 1 is,

\[
Z(jw) = \frac{(1/jwC_0)(R_1 + 1/jwC_1 + jwL_1)}{1/jwC_0 + R_1 + 1/jwC_1 + jwL_1}
\]  

(1.1)
Where
\( j = \text{Imaginary operator} = \sqrt{-1} \)
\( w = \text{radian frequency} = 2\pi f \)

Equation (1.1) is complex impedance but our interest will be in the imaginary part of it, or its reactance. Figure 2 depicts this.

**Figure 2:** Plot of reactance versus frequency of a quartz crystal

There are four key facts in Figure 2.

First, \( f_s \) is the frequency at which the motional capacitance \( C_1 \) cancels the motional inductance \( L_1 \). Second, \( f_s \) is called the “series resonance” of the crystal and is expressed by

\[
f_s = \frac{1}{2\pi \sqrt{L_1 C_1}}
\]  

(1.2)

Third, the anti-resonant point or parallel resonance \( f_a \), is where the motional inductance \( L_1 \) resonates with the parallel combination of \( C_1 \) and \( C_0 \). Fourth, \( f_a \) is expressed by

\[
f_a = \frac{1}{2\pi \sqrt{\frac{L_1}{C_0 C_1} \frac{C_0 + C_1}{C_0 + C_1}}}
\]  

(1.3)
Pulling the Frequency by Changing the Load Capacitance

Many applications require changing the frequency of the crystal. One example is a VCXO (Voltage Controlled Crystal Oscillator), where it is necessary to tune the operating frequency to a desired value or to vary the frequency over a desired voltage range. As the capacitive load in series with the crystal is varied, the crystal frequency is pulled. This change of the frequency with load capacitance $C_L$ is expressed by:

$$\frac{f_L - f_s}{f_s} = \frac{\Delta f}{f_s} = \frac{C_1}{2(C_L + C_0)} \times 10^6 \text{ (in ppm)} \quad (1.4)$$

Where

- $f_L$ = frequency with the load capacitance
- $f_s$ = frequency at series resonance
- $C_1$ = motional capacitance of crystal
- $C_0$ = shunt capacitance of crystal

and

$$\frac{\Delta f}{f_s} = \text{fractional frequency change} \quad (1.5)$$

Note that the equation (1.4) is written as a delta from series resonance frequency to load resonance frequency. In other words, the fractional frequency changes from $f_s$ to $f_L$.

Reducing the value of the load capacitance will increase the frequency of the crystal. Eventually, the frequency of $f_a$ will be reached, but should be avoided in crystal oscillators. This leads to

$$\lim_{C_L \to 0} \left( \frac{C_1}{2(C_L + C_0)} \right) = \frac{C_1}{2C_0} \quad (1.6)$$

The result of (1.6) is the fractional frequency distance to the pole, or $f_a$ to $f_s$. This is known as the zero to pole spacing, and sets the limit on the total pullability of a crystal.
A graphic representation of (1.4) of a typical pulling curve:

![Graph showing Delta Frequency Shift vs Load Capacitance](image)

**Figure 3:** Plot of equation (1.4). Typical Crystal Frequency Pulling Curve vs Load Capacitance where the motional capacitance $C_1 = 0.01$ pF and the shunt capacitance $C_0 = 5$ pF. With 20 pF in series with this crystal, the frequency is +200 PPM above the Series Resonance frequency.

The first derivative of the equation (1.4) with respect to $C_L$ results in

$$TS = -\left(\frac{C_1}{2(C_0 + C_L)^2}\right) \times 10^{-6} \text{ (in ppm / pF)}$$

(1.7)
Crystal manufacturers call equation (1.7) of the crystal’s given load capacitance, “Trim Sensitivity”. Figure 4 is the graphic representation of “Trim Sensitivity”.

![Graph showing Trim Sensitivity](image)

**Figure 4:** Plot of equation (1.7). Typical Crystal Trim Sensitivity versus Load Capacitance, where the motional capacitance $C_1 = 0.01$ pF and the shunt capacitance $C_0 = 5$ pF. At a $C_L$ of 10pF, $TS = -22.22$ PPM/pF. At a $C_L = 20$pF, $TS = -8$ PPM/pF.

The Trim Sensitivity equation (1.7) gives an important insight into how to choose the load capacitance value for the crystal. If the designer’s goal is make a fixed frequency oscillator, such as in a microprocessor application, then he/she chooses a large load capacitance value like 18 - 22pF. If the designer wants to pull the crystal, then he/she chooses a small load capacitance value like 9pF - 14pF.
Crystals Have Many Responses!

All crystals have many resonant responses (See Figure 5). The first major response is called the “Fundamental”. To the right of it, is the next major response which is the 3rd Overtone, then the 5th Overtone, and so on. There are only odd overtones. The overtone responses are not harmonics of the fundamental. By definition, a harmonic is an exact multiple of a lower frequency. For example, the 3rd Overtone usually lies between 2.8 to 3.2 times the fundamental. So crystals have no harmonics, but overtones.

Examine Figure 5 and notice that crystal behaves like a resistor at some frequency points, and like an inductor or capacitor at other frequency regions. The circuit topology connected to the crystal determines where to operate the crystal. In other words, the circuit forces the crystal into either fundamental, parallel, overtone or series mode. See definitions below.

“Load Capacitance”: The frequency of the crystal will vary depending on the capacitive reactance in series with the crystal. Therefore, the designer must specify the capacitance value needed to calibrate the crystal to frequency. Typical values are between 9 - 32 pF; with 18 - 20 pF being the most common. The Load Capacitance is effectively placed in series with the crystal, never across it.
“Parallel Crystal”: A crystal calibrated to the desired frequency at one of the inductive regions of the crystal’s reactance curve. Since it is a region, the designer must identify exactly where in the region he/she needs the crystal to operate. The exact point in the region is controlled by the value of the load capacitance.

“Series Crystal”: A crystal calibrated to the desired frequency at one of the resistive points on the crystal’s reactance curve. The resistive point can be on the fundamental or one of the overtone responses. No Load Capacitance needs to be specified, since it is a point of operation and not a region.

“Fundamental Crystal”: A crystal designed and calibrated to the desired frequency on the lowest major resonant response. A Fundamental crystal can be calibrated as “Series” or “Parallel”.

“Overtone Crystal”: A crystal calibrated to the desired frequency at a major response other than the fundamental. An Overtone crystal can be calibrated as “Series” or “Parallel”.

“Equivalent Series Resistance (E.S.R)”: The resistance of the crystal at Series resonance is simply the motional resistance $R_1$. In the region of parallel resonance, its value increases to:

$$E.S.R = R_1 \left[ 1 + \frac{C_0}{C_L} \right]^2$$

Therefore, E.S.R is the resistance or loss of the crystal in the parallel resonance region.

Note, it is important to understand that every crystal is able to operate in fundamental or any overtone mode, at series and parallel resonance. It is just a matter of matching the crystal manufacturer’s calibration condition to the condition applied to the crystal terminals by the surrounding circuitry.